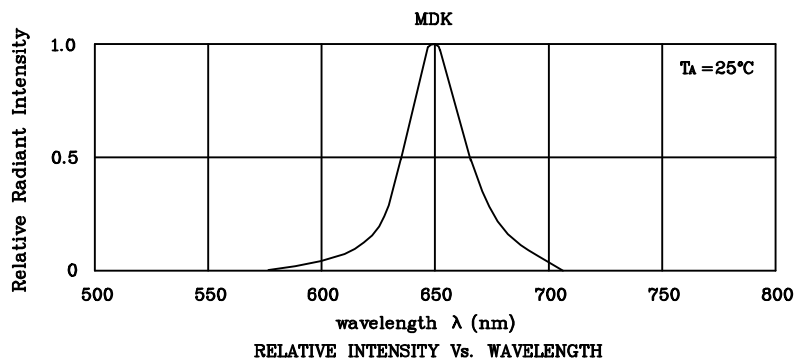
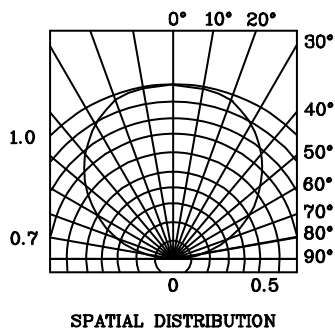
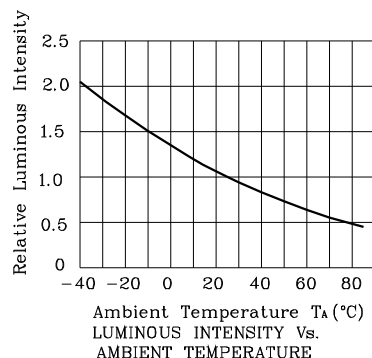
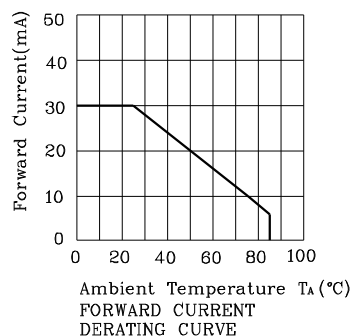
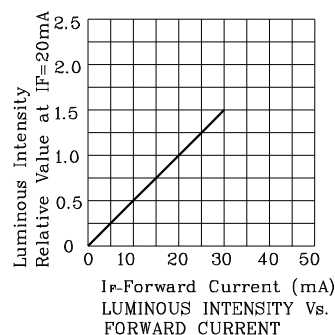
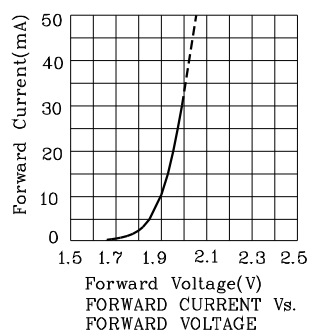
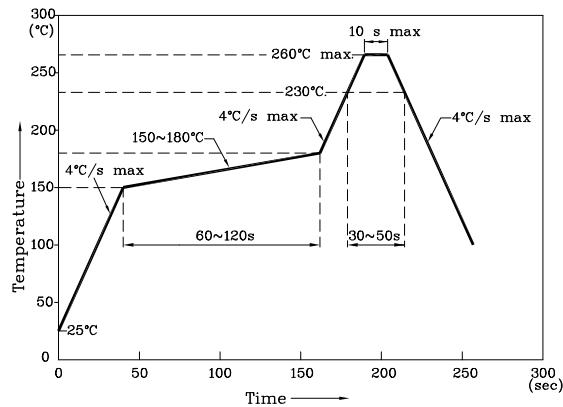




❖ **MDK**



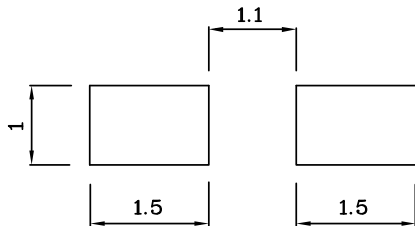
Reflow Soldering Profile For Lead-free SMT Process.



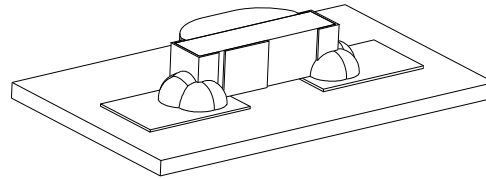
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C–260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

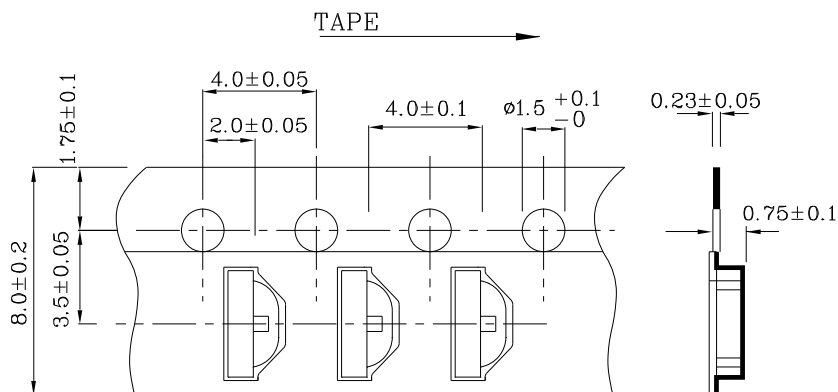
❖ Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:

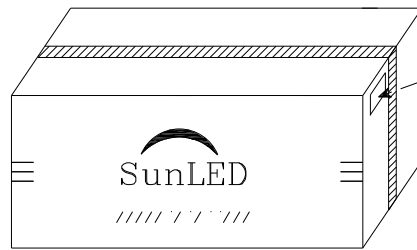
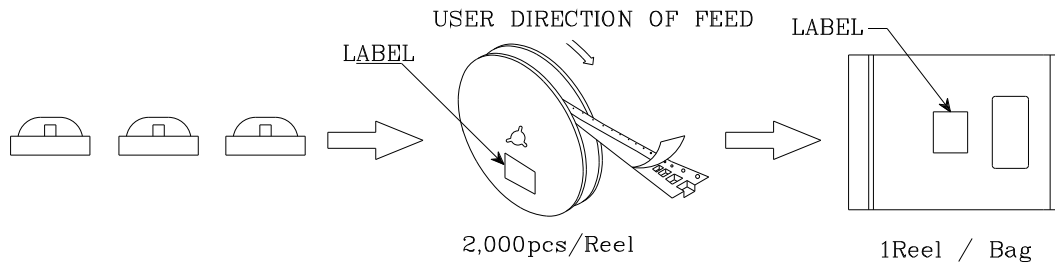
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous intensity / Luminous Flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

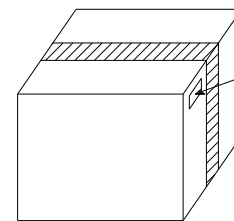
Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

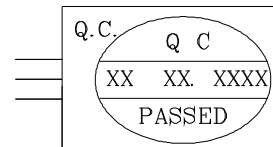
ZMDK74W



OUTSIDE
LABEL



OUTSIDE
LABEL



P/NO : Zxxx74x

QTY : 2,000 pcs

CODE: XXX

S/N : XX

LOT NO:



RoHS Compliant